

2A, 1-Cell Li-Ion Battery Charger with Battery Voltage Exceeding 2.1V in QFN-16 (3mmx3mm) Package

DESCRIPTION

The MP2615D is a monolithic switching charger for 1-cell lithium-ion or lithium-polymer battery packs with built-in power MOSFETs. It can achieve up to 2A of charge current (I_{CC}), which can be configured via an accurate current-sense resistor across the entire input voltage (V_{IN}) range.

The MP2615D regulates the charge current and battery-full voltage (V_{BATT_FULL}) using two control loops to achieve highly accurate constant-current (CC) charge and constant-voltage (CV) charge.

With constant-off-time (COT) mode control, a 99% duty cycle can be achieved when the battery voltage (V_{BATT}) is close to V_{IN} . This process maintains the charge current at a relatively high level.

The battery temperature and charging status are always monitored for each condition. Two status monitor output pins are provided to indicate the battery charging status and input power status. The MP2615D also features internal reverse-blocking protection.

The MP2615D is available in a QFN-16 (3mmx3mm) package.

FEATURES

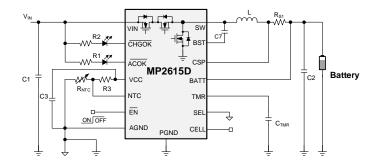
- 4.5V to 18V Operating Input Voltage (V_{IN}) Range
- Up to 99% Duty Cycle Operation
- Up to 2A Configurable Charging Current (I_{CC})
- ±0.75% Battery-Full Voltage (V_{BATT_FULL}) Accuracy
- 4.05V/4.13V VBATT FULL
- No Charge when Battery Voltage (V_{BATT})
 < 2.1V
- Fully Integrated Power Switches
- Internal Loop Compensation
- No External Reverse-Blocking Diode Required
- Preconditioning for Fully Depleted Battery
- Charging Operation Indicator
- Configurable Safety Timer
- Thermal Shutdown Protection
- Cycle-by-Cycle Over-Current Protection (OCP)
- Battery Temperature Monitor and Protection
- Available in a QFN-16 (3mmx3mm) Package

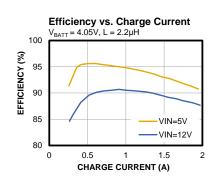
APPLICATIONS

- Smartphones
- Portable Handheld Solutions
- Portable Media Players

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TYPICAL APPLICATION







ORDERING INFORMATION

Part Number*	Package	Top Marking	MSL Rating
MP2615DGQ	QFN-16 (3mmx3mm)	See Below	1

^{*} For Tape & Reel, add suffix -Z (e.g. MP2615DGQ-Z).

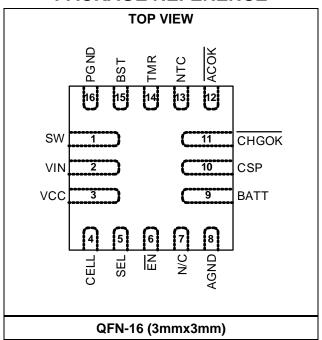
TOP MARKING

CCZY

CCZ: Product code of MP2615DGQ

Y: Year code LLLL: Lot number

PACKAGE REFERENCE





PIN FUNCTIONS

Pin #	Name	Description
1	SW	Switch output. (1)
2	VIN	Power supply voltage.
3	VCC	Coarse regulator output. The VCC pin has an internally generated 4.5V. Bypass VCC with a $1\mu F$ capacitor connected to AGND. The VCC pin provides power to the low-side switch driver as well as the pull-up bias voltage for the NTC resistor divider. Do not connect any external load at this pin.
4	CELL	Float this pin or connect to GND.
5	SEL	Option for battery full voltage selection. When SEL is low or floating, the battery-full voltage (VBATT_FULL) is set to 4.05V (typically); when SEL is set high, VBATT_FULL is set to 4.13V (typically).
6	EN	On/off control input. This pin is pulled down to AGND with a $1M\Omega$ internal resistor.
7	N/C	No connection. Float this pin.
8	AGND	Analog ground.
9	BATT	Positive battery terminal.
10	CSP	Battery current-sense positive input. Connect a resistor (R _{S1}) between the CSP and BATT pins.
11	CHGOK	Charging completion indicator. A low logic on this pin indicates the charging operation. This pin becomes an open drain once charging is completed or suspended.
12	ACOK	Valid input supply indicator. A low logic on this pin indicates the presence of a valid input power supply.
13	NTC	Thermistor input. Connect a resistor from the NTC pin to the VCC pin. In addition, connect a thermistor from this pin to ground.
14	TMR	Internal safety timer control. Connect a capacitor from this node to AGND to set the timer. The timer can be disabled by connecting this pin to AGND directly.
15	BST	Bootstrap. A capacitor is required to drive the power switch's gate above the supply voltage. Connect this capacitor between the SW and BST pins to form a floating supply across the power switch driver.
16	PGND	Power ground.

Note:

1) During start-up, the SW voltage (V_{SW}) can exceed the absolute voltage for a short period of time (<200ns).



ABSOLUTE MAXIMUM RATINGS (2)

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V _{SW}	0.3V to +23V
V _{IN} , V _{ACOK} , V _{CHGOK}	0.3V to +23V
V _{BATT} , V _{CSP}	0.3V to +12V
V _{BST}	
All other pins	0.3V to +6V
Junction temperature (T _J)	150°C
Lead temperature	260°C
Continuous power dissipation	'
Operating temperature	40°C to +85°C
ESD Ratings	
Human body model (HBM)	±1kV
Charged-device model (CDM).	±750V
Recommended Operating	Conditions (4)
V _{IN}	4.5V to 18V
V _{BATT}	2V to 4.03V
Operating junction temp (T _J)	40°C to +125°C

Thermal Resistance (5)	$oldsymbol{ heta}$ JA	$oldsymbol{ heta}$ JC	
QFN-16 (3mmx3mm)	50	12	°C/W

Notes:

- 2) Exceeding these ratings may damage the device.
- 3) The maximum allowable power dissipation is a function of the maximum junction temperature, T_J (MAX), the junction-to-ambient thermal resistance, θ_{JA} , and the ambient temperature, T_A . The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = $(T_J$ (MAX) $T_A)$ / θ_{JA} . Exceeding the maximum allowable power dissipation can cause excessive die temperature, and the regulator may go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 5) Measured on a JESD51-7, 4-layer PCB.



ELECTRICAL CHARACTERISTICS

 V_{IN} = 12V, V_{CELL} = 0V, V_{SEL} = 0V, C1 = 22 μ F, C2 = 22 μ F, T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Input Voltage and Curre	ent					
Input voltage	V _{IN}	Cell floating	4.5	12	18	V
Under-voltage lockout (UVLO) rising threshold	V _{UVLO}		3.55	3.76	3.97	V
UVLO hysteresis				250	470	mV
Supply current (shutdown)	Ishdn	EN = 4V		0.27		mA
Supply current (quiescent)	lα	EN = 0V		1.1		mA
Power MOSFET						
High-side MOSFET (HS-FET) on resistance	Rh_ds(on)	Measured from VIN to SW		110		mΩ
Low-side MOSFET (LS-FET) on resistance	R _{L_DS(ON)}			110		mΩ
Switch leakage		$\overline{EN} = 4V, V_{SW} = 0V$		0	1	μA
Frequency and Time Pa	rameter					
Switching frequency fsw VBATT		V _{BATT} = 3.8V	842	1000	1158	kHz
Minimum off time (6)	t _{OFF}	$V_{BATT} = 4.5V$		200		ns
Charging Parameters						
Terminal battery voltage	VBATT_FULL	V _{SEL} = 0V	4.03	4.05	4.07	V
Terrilliai battery voltage		V _{SEL} = 4V	4.11	4.13	4.15	
Battery over-voltage	V _{BOVP}	V _{SEL} = 0V	4.1	4.21	4.3	
(OV) threshold	V BOVP	V _{SEL} = 4V	4.2	4.3	4.4	
Recharge threshold at	V _{RECH}	V _{SEL} = 0V		3.92		
battery voltage (VBATT)	VRECH	V _{SEL} = 4V		4		
Recharge hysteresis				40		mV
Battery under-voltage		Vsel = 0V		2.03		V
protection (UVP) falling threshold	V _{BATT_UV}	V _{SEL} = 4V		2.07		
Battery UV hysteresis				110		mV
Trickle charge voltage threshold	V _{TC}	V _{SEL} = 0V		3		V
Trickle charge hysteresis				220		mV
Poak current limit		CC ⁽⁶⁾	2.9	3.8		^
Peak current limit		Trickle		2.2		A
Constant-current (CC) charge current	Icc	$R_{S1} = 47 \text{m}\Omega$	0.9	1	1.1	А



ELECTRICAL CHARACTERISTICS (continued)

 V_{IN} = 12V, V_{CELL} = 0V, V_{SEL} = 0V, C1 = 22 μ F, C2 = 22 μ F, T_A = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Trickle charge current	Ітс		4%	10%	16%	Icc
Termination current threshold	I _{BF}		4%	10%	16%	lcc
V _{IN} minimum headroom (reverse blocking)		VIN - VBATT		300		mV
Maximum current-sense voltage (CSP to BATT)	V _{SENSE}		42.3	47.0	51.7	mV
CSP, BATT current	ICSP, IBATT	Charging disabled			0.5	μΑ
ACOK / CHGOK open- drain sink current		V _{DRAIN} = 0.3V	5			mA
VCC Regulator Output						
VCC output voltage	Vcc		4.17	4.5	4.82	V
VCC load regulation	ΔVcc	I _{LOAD} = 0 to 10mA			10	mV
EN Control						
EN input low voltage					0.4	V
EN input high voltage			1.9			V
EN input current		EN = 4V		4		
	I _{EN}	EN = 0V		0.2		μΑ
Timer Protection						
Trickle charge time	t _{TRICKLE_TMR}	$C_{TMR} = 0.47 \mu F$		30		min
CC/CV charge time	ttotal_tmr	$C_{TMR} = 0.47 \mu F$		165		min
NTC Protection						
NTC low temp rising threshold		R _{NTC} = NCP18X103, 0°C ⁽⁷⁾ ,	70.5%	73.3%	74.6%	
NTC low temp rising threshold hysteresis		$T_A = -20^{\circ}\text{C to } +85^{\circ}\text{C}^{(6)}$		2%		Vcc
NTC high temp falling threshold		R _{NTC} = NCP18X103,50°C ⁽⁷⁾ ,	28%	29.3%	30.6%	VCC
NTC low temp falling threshold hysteresis		$T_A = -20$ °C to +85°C ⁽⁶⁾		2%		
Thermal Protection						
Thermal shutdown (6)	T _{SHDN}			150		°C
Thermal shutdown hysteresis ⁽⁶⁾				20		°C
Reverse Leakage Blocking	g					
Battery reverse leakage current	ILEAKAGE				0.5	μΑ

Notes:

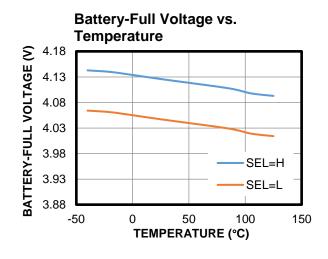
⁶⁾ Guaranteed by design.

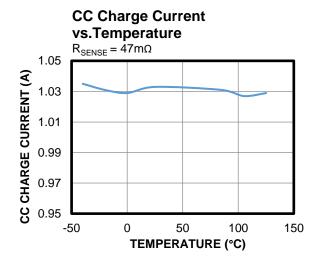
⁷⁾ This is the operation temperature limit when using the specified NTC resistor.

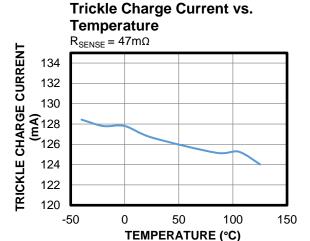


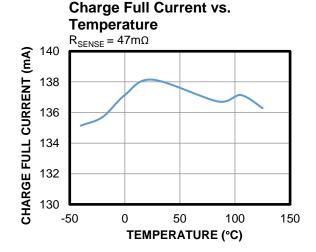
TYPICAL PERFORMANCE CHARACTERISTICS

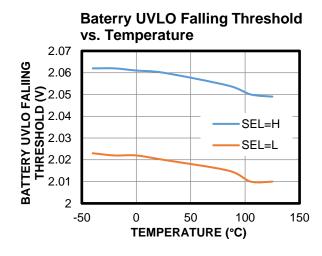
 V_{IN} = 12V, C1 = C2 = 22 μ F, SEL = GND, CELL = floating, L = 2.2 μ H, R_{S1} = 47m Ω , battery simulator, T_A = 25°C, unless otherwise noted.

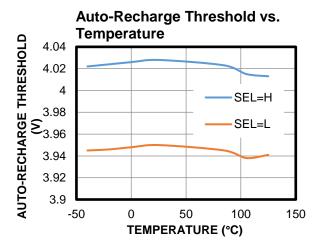








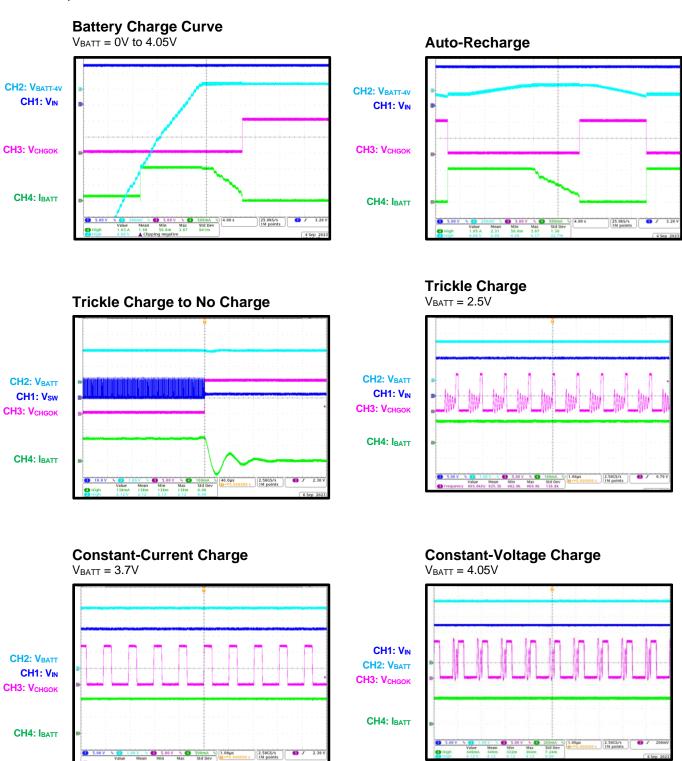






TYPICAL PERFORMANCE CHARACTERISTICS

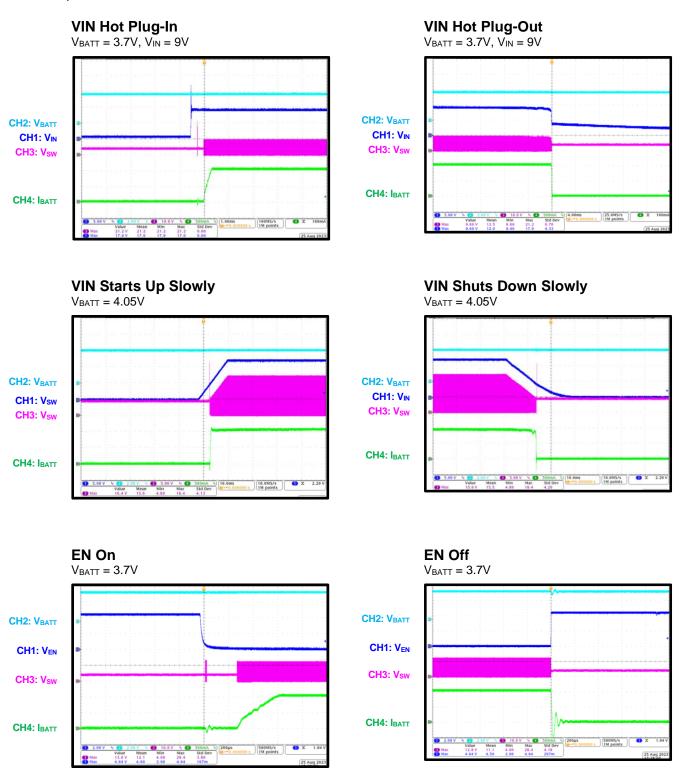
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TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{IN} = 12V, C1 = C2 = 22 μ F, SEL = GND, CELL = floating, L = 2.2 μ H, R_{S1} = 47m Ω , battery simulator, T_A = 25°C, unless otherwise noted.



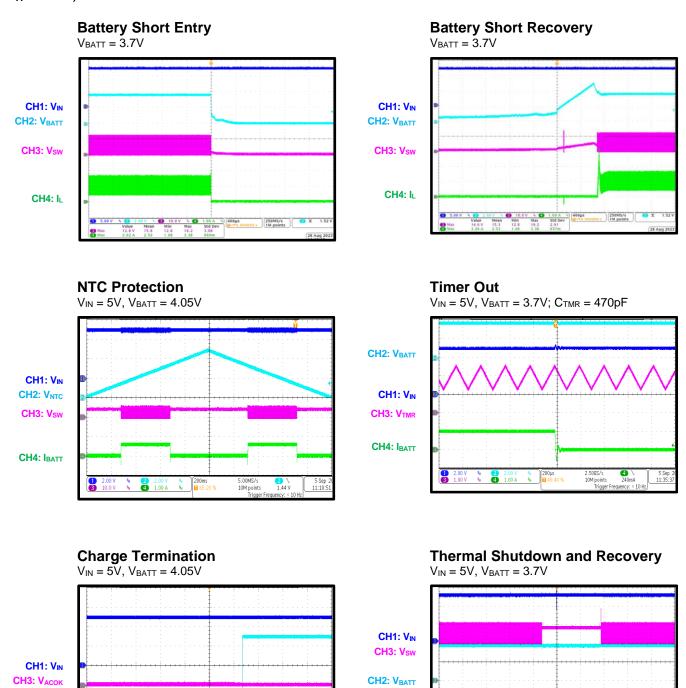


CH2: VCHGOK

CH4: I_{BATT}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 V_{IN} = 12V, C1 = C2 = 22 μ F, SEL = GND, CELL = floating, L = 2.2 μ H, R_{S1} = 47m Ω , battery simulator, T_A = 25°C, unless otherwise noted.



CH4: IBATT



FUNCTIONAL BLOCK DIAGRAM

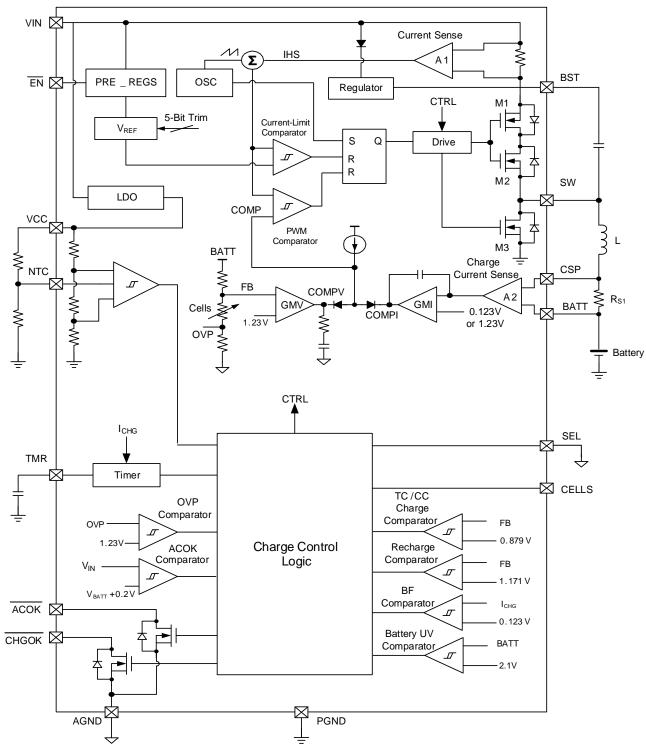


Figure 1: Functional Block Diagram



OPERATION

The MP2615D is a peak current mode control switching charger for 1-cell lithium-ion and lithium-polymer batteries. The MP2615D integrates both the high-side and low-side MOSFETs (HS-FET and LS-FET, respectively) of the synchronous buck converter to provide high efficiency and reduce PCB size.

Charge Cycle (Mode Change: TC to CC to CV)

The MP2615D regulates the charge current (I_{CHG}) and battery voltage (V_{BATT}) using two control loops to achieve highly accurate constant current (CC) charge and constant voltage (CV) charge.

If $V_{BATT_UV} < V_{BATT} < V_{TC}$, the MP2615D stays in trickle charge mode, and the output of the charge current loop (COMPI) dominates the

control (see Figure 2). The battery is charged by a trickle charge current (I_{TC}) until the battery voltage reaches V_{TC} . If the charger remains in trickle charge mode until the trickle charge timer is triggered, charging is terminated.

The MP2615D enters CC charge mode once V_{BATT} exceeds V_{TC} . In this mode, the current loop continues dominating the control, and the charge current increases from I_{TC} to I_{CC} to quickly charge the battery.

If the V_{BATT} exceeds the battery-full voltage (V_{BATT_FULL}), the charger enters CV mode. In CV mode, the battery voltage is regulated at V_{BATT_FULL} , and the charge current falls naturally due to the battery's existing equivalent internal resistance. Figure 4 on page 15 shows the operation flowchart.

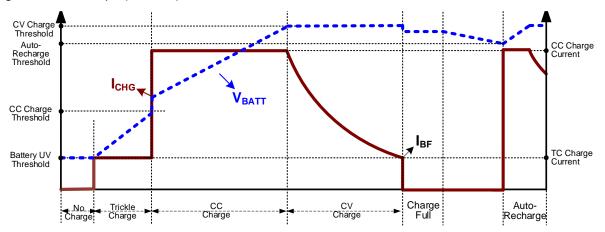


Figure 2: Li-Ion Battery Charge Profile

Charge Full Termination and Auto-Recharge

If the charge current drops below the termination threshold (I_{BF}) during the CV charge phase, the charger stops charging and the $\overline{\text{CHGOK}}$ pin becomes an open drain. The timer resets and turns off. Once the battery voltage drops below the recharge threshold (V_{RECH}), recharging automatically begins and the timer restarts a new charge cycle.

Constant-Off-Time (COT) Charge Mode

The MP2615D uses the floating ground method to drive the buck converter's HS-FET. When the HS-FET is off, the BST capacitor is recharged and the voltage across it is used for the HS-FET's gate drive. A minimum off time of 200ns

is required to maintain sufficient voltage at the BST capacitor.

If the 200ns minimum off time is reached due to a large duty cycle, the MP2615D enters constant-off-time (COT) charge mode. In this mode, the switching frequency (f_{SW}) is slightly reduced to achieve a 99% duty cycle.

Charge Status Indication

The MP2615D has two open-drain status outputs: the \overline{CHGOK} pin and \overline{ACOK} pin. The \overline{ACOK} pin goes low when the input voltage (V_{IN}) exceeds its under-voltage lockout (UVLO) threshold and exceeds V_{BATT} by 300mV.

CHGOK indicates the charge cycle status.



Table 1 shows the operation of both $\overline{\text{CHGOK}}$ and $\overline{\text{ACOK}}$ according to the charge status.

Table 1: Charging Status Indication

ACOK	CHGOK	Charger Status		
Low	Low	In charging		
Low	High- impedance	 End of charge V_{BATT} < 2.1V NTC fault Timer out EN disabled Thermal shutdown 		
High-	High-	 V_{IN} absent 		
impedance	impedance	 V_{IN} - V_{BATT} < 0.3V 		

Safety Timer Operation

The MP2615D has an internal safety timer to terminate charging during timeout. The capacitor (C_{TMR}) connected between the TMR pin and GND is used to set the internal oscillator period, calculated with Equation (1):

$$t_{P}(\text{seconds}) = 0.46 \times C_{TMR}(\mu F)$$
 (1)

This timer limits the maximum trickle charge time to 8192 internal oscillating periods. If the charger remains in trickle charge mode for longer than the maximum oscillating periods, charging is terminated and CHGOK becomes an open drain to indicate a timeout fault. If the charge cycle successfully completes trickle charge within the allowed time limit, it enters CC charge mode and the timer continues to count the oscillating periods. When the battery is fully charged, the timer turns off and clears the counter, waiting for the auto-recharge to restart.

If the charge time during CC/CV mode exceeds 49152 oscillating periods, and the battery-full condition has not been met, charging is terminated and a timeout fault is indicated by floating the CHGOK pin. The charger can exit the timeout fault state (and restart on-chip safety timer counting) when one of the following conditions occurs:

- V_{BATT} falls below V_{RECH}
- A power-on-reset (POR) event occurs
- The EN pin is toggled

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The timer can be disabled by pulling TMR-pin to AGND.

The trickle mode charge time can be estimated with Equation (2):

$$t_{TRICKLE\ TMR}$$
 (minutes) = $62.8 \times C_{TMR}$ (μF) (2)

If C_{TMR} is 0.47 μ F, the trickle charge time is about 30 minutes. The CC/CV mode charge time can be calculated with Equation (3):

$$t_{TOTAL\ TMR}$$
 (hours) = $6.28 \times C_{TMR}$ (μF) (3)

In this case, if C_{TMR} is 0.47 μ F, the CC/CV charge time is 2.95 hours.

Negative Thermal Coefficient (NTC) Thermistor

The NTC pin allows the MP2615D to sense the battery temperature using the negative thermal coefficient (NTC) resistor in the battery pack. This ensures a safe operating environment for the battery. A resistor with an appropriate value should be connected from the VCC pin to the NTC pin, and the thermistor should be connected from the NTC pin to AGND. The voltage on the NTC pin is determined by the resistor divider, which has a divide ratio that depends on the battery temperature. When the voltage at the NTC pin falls out of the NTC window range, charging pauses until the battery temperature returns to within the normal operating range.

As a result, the MP2615D stops charging and reports this condition to the status pins. The timer is suspended but continues counting from where it left off when charging resumes.

Thermal Shutdown Protection

To prevent the chip from overheating during charging, the MP2615D monitors the die's junction temperature (T_J). If T_J reaches the thermal shutdown threshold (T_{SHTDWN}) of 150°C, the charger converter turns off. Once T_J falls below 130°C, charging restarts.

Battery Under-Voltage Protection (UVP)

When the chip detects that V_{BATT} has fallen below the V_{BATT_UVLO} falling threshold, charging stops. Once V_{BATT} exceeds the V_{BATT_UVLO} rising threshold, charging starts up again.



INPUT START-UP TIMING DIAGRAM

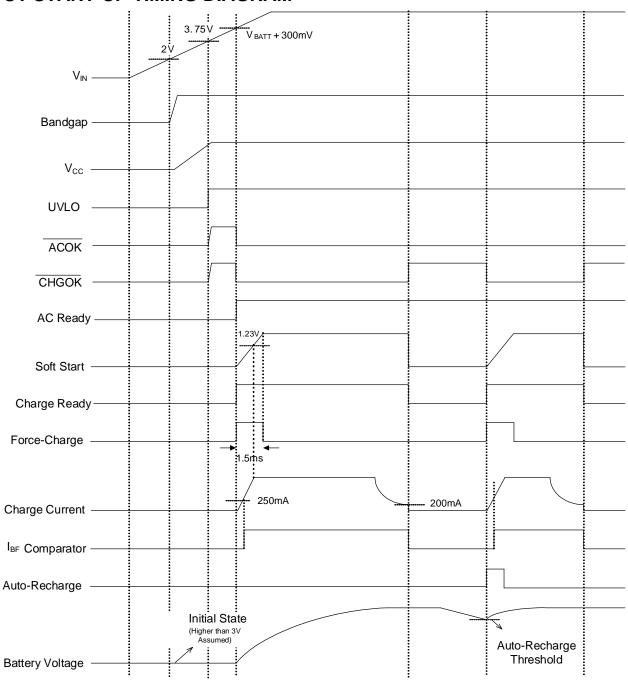


Figure 3: Input Power Start-Up Timing Diagram



OPERATION FLOWCHART

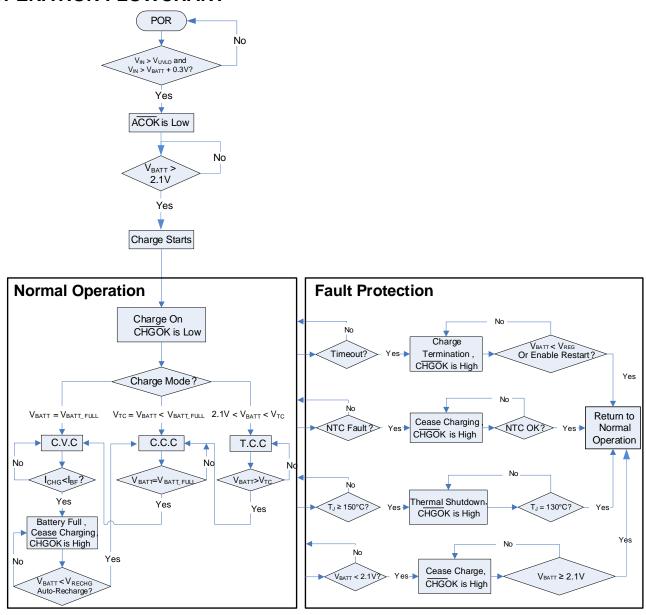


Figure 4: Operation Flowchart



APPLICATION INFORMATION COMPONENT SELECTION

Charge Current Setting

The constant charge current (I_{CC}) can be set by the current-sense resistor (R_{S1}). The configurable I_{CC} can be estimated with Equation (4):

$$I_{CC} = \frac{47mV}{R_{S1}(m\Omega)}(A)$$
 (4)

If 1A I_{CC} is 1A, choose R_{S1} to be $47m\Omega$.

The trickle charge current (I_{TC}) can calculated with Equation (5):

$$I_{TC} = 10\%I_{CC} = \frac{4.7mV}{R_{S1}(m\Omega)}(A)$$
 (5)

Selecting the Inductor

To select the optimal inductor, a tradeoff should be made between cost, size, and efficiency. A smaller-value inductor has the benefit of a smaller size, but it also has higher ripple currents, magnetic hysteretic losses, and output capacitance. Conversely, a larger-value inductor lowers the ripple current and allows for the use of smaller output filter capacitors, but it also results in higher inductor DC resistance (DCR) loss.

Based on practical experience, the inductor ripple current should not exceed 15% of the maximum charge current under the worst-case conditions. For the MP2615D, with a typical 12V input voltage to charge a 1-cell battery, the maximum inductor current ripple occurs at the corner point between trickle charge and CC charge ($V_{BATT} = 3V$). Estimate the required inductance with Equation (6):

$$L = \frac{V_{IN} - V_{BATT}}{\Delta I_{I MAX}} \frac{V_{BATT}}{V_{IN} \times f_{SW}}$$
 (6)

Where V_{IN} is the input voltage, V_{BATT} is the CC charge threshold, and f_{SW} is the switching frequency.

 ΔI_{L_MAX} is the maximum inductor ripple current, which is usually 30% of the CC charge current, calculated with Equation (7):

$$\Delta I_{L_MAX} = 0.30 \times I_{CC} \tag{7}$$

If $I_{CC}=2A$, $V_{IN}=12V$, $V_{BATT}=3V$, and $f_{SW}=1000$ kHz, the calculated inductance is 3.75 μ H. The inductor's saturated current must exceed 2.6A and have some tolerance. For $V_{IN}=5V$ applications, the calculated inductance is 2μ H, so select the inductance to be 2.2 μ H or 3.3 μ H for the application. To optimize efficiency, choose an inductor with the lowest possible DCR.

Selecting the NTC Resistor Divider

Figure 5 shows how an internal resistor divider sets the cold temperature threshold and hot temperature threshold at 73.3% of V_{CC} and 31.1% of V_{CC} , respectively.

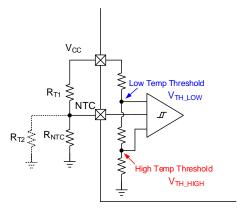


Figure 5: NTC Function Block

For a given NTC thermistor, select the appropriate R_{T1} and R_{T2} to set the NTC window. The thermistor (NCP18XH103) in Figure 5 has the following electrical characteristics:

- At 0°C, $R_{NTC COLD} = 27.445k\Omega$
- At 50°C, $R_{NTC HOT} = 4.1601 k\Omega$

Assuming that the NTC window is between 0°C and 50°C, the low and high thresholds can be calculated with Equation (8) and Equation (9), respectively:

$$\frac{R_{T2}//R_{NTC_COLD}}{R_{T1} + R_{T2}//R_{NTC_COLD}} = \frac{V_{TH_LOW}}{VREF33} = 73.3\%$$
 (8)

$$\frac{R_{T2}//R_{NTC_HOT}}{R_{T1} + R_{T2}//R_{NTC_HOT}} = \frac{V_{TH_HIGH}}{VREF33} = 29.3\%$$
 (9)

The required battery temperature range can be paired with Equation (8) and Equation (9) to calculate R_{T1} and R_{T2} .



Selecting the Input Capacitor

The input capacitor (C1) from the typical application circuit absorbs the maximum ripple current from the buck converter (see Figure 7 on page 19). The maximum ripple current can be estimated with Equation (10):

$$I_{RMS_MAX} = I_{CC} \frac{\sqrt{V_{TC}(V_{IN_MAX} - V_{TC})}}{V_{IN_MAX}}$$
(10)

If $I_{CC} = 2A$, $V_{TC} = 3V$, and $V_{IN_MAX} = 18V$, then the maximum ripple current is close to 1A. Select the input capacitors so that the temperature rise due to the ripple current does not exceed 10°C. Use ceramic capacitors with X5R or X7R dielectrics because of their low ESR and small temperature coefficients. For most applications, use a 22µF capacitor.

Selecting the Output Capacitor

The output capacitor (C2) from the typical application circuit is in parallel with the battery (see Figure 7 on page 19). C2 absorbs the high-frequency switching ripple current and smooths the output voltage. Its impedance must be far below that of the battery to ensure that it absorbs the ripple current.

Use a ceramic capacitor because it has lower ESR and smaller size, which allows us to ignore its ESR. The output voltage ripple can be calculated with Equation (11):

$$\Delta R_{O} = \frac{\Delta V_{OUT}}{V_{OUT}} = \frac{1 - \frac{V_{OUT}}{V_{IN}}}{8 \times C2 \times f_{SW}^{2} \times L}$$
(11)

To guarantee the ±0.5% battery-full voltage accuracy, the maximum output voltage ripple must not exceed 0.5% (e.g. 0.1%). The maximum output voltage ripple occurs at the minimum battery voltage of the CC charge and the maximum input voltage.

If $V_{IN_MAX} = 18V$, $V_{CC_MIN} = V_{TC} = 3V$, $L = 3.75 \mu H$, $f_{SW} = 1000kHz$, and $\Delta R_{O_MAX} = 0.2\%$, then the output capacitance can be estimated with Equation (12):

$$C2 = \frac{1 - \frac{V_{TC}}{V_{IN_MAX}}}{8 \times f_{SW}^2 \times L \times \Delta R_{0_MAX}} = 13.8(\mu F) \quad (12)$$

In this scenario, choose a 22µF ceramic capacitor.



PCB Layout Guidelines

Proper PCB layout is vital to meet specified noise, efficiency, and stability requirements. For the best results, refer to Figure 6 and follow the quidelines below:

- 1. Route the power stages adjacent to their grounds.
- 2. Minimize the high-side switching node (SW and inductor) trace lengths in the highcurrent paths and the current-sense resistor trace.
- 3. Keep the switching node short and route it away from the feedback network.

- 4. Connect the charge current sense resistor to CSP (pin 10) and BATT (pin 9). Minimize the length and area of this circuit loop.
- 5. Place the input capacitor as close as possible to the VIN and PGND pins.
- 6. Place the output inductor close to the IC.
- 7. Connect the output capacitor between the inductor and PGND of the IC. minimizes the current path loop area from the SW pin through the LC filter and back to the PGND pin.
- 8. Connect AGND and PGND at a single point.

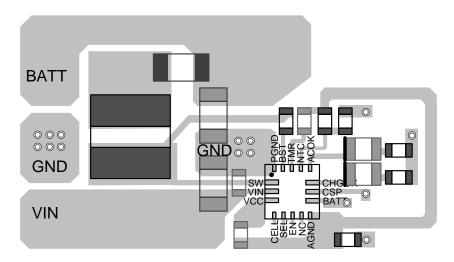


Figure 6: Recommended PCB Layout



TYPICAL APPLICATION CIRCUIT

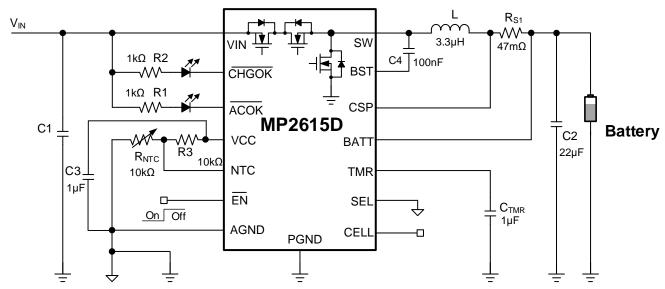
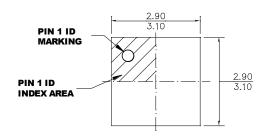


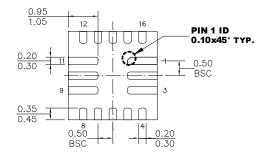
Figure 7: Typical Application Circuit (V_{IN} = 12V)



PACKAGE INFORMATION

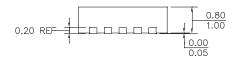
QFN-16 (3mmx3mm)



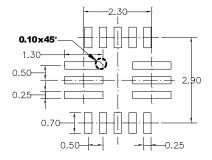


TOP VIEW

BOTTOM VIEW



SIDE VIEW



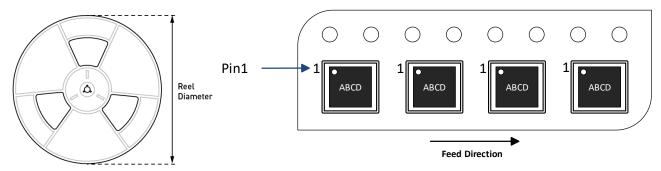
NOTE:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS
 2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
- 3) LEAD COPLANARITY SHALL BE0.10 MILLIMETERS MAX
- 4) JEDEC REFERENCE IS MG220.
- 5) DRAWING IS NOT TO SCALE

RECOMMENDED LAND PATTERN



CARRIER INFORMATION



Part Number	Package Description	Quantity/ Reel	Quantity/ Tube	Quantity/ Tray	Reel Diameter	Carrier Tape Width	Carrier Tape Pitch
MP2615DGQ-Z	QFN-16 (3mmx3mm)	5000	N/A	N/A	13in	12mm	8mm



REVISION HISTORY

Revision #	Revision Date	Description	Pages Updated
1.0	5/29/2024	Initial Release	-

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